

Impedance modeling: simulations, minimization

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Outline



- Broadband impedance
- Narrowband impedance
- Computer modelling
- Examples
 - Bellows
 - Tapers
 - BPM's
 - Resistive wall
 - Cavities
 - Kickers

Impedance related effects



- **Broadband**

- Microwave instability

$$I_p = \frac{2\pi |\eta| \left(\frac{E}{e}\right) (\beta\sigma_p)^2}{\left|\frac{Z_{\parallel}}{n}\right|_{\text{eff}}}$$

- Transverse mode coupling

$$I_b = \frac{4 \left(\frac{E}{e}\right) v_s}{\left\langle \text{Im}(Z_{\perp}) \beta_{\perp} \right\rangle R} \frac{4\sqrt{\pi}}{3} \sigma_{\perp}$$

- Related to “effective” impedance experienced by a single bunch
 - Short-range wakefield
 - » All vacuum chamber components

- **Narrowband**

- Coupled-bunch instabilities

$$\Delta\omega_{\text{transverse}} = -j \frac{I f_0}{2\frac{E}{e}} \beta_{x,y} Z_{\text{eff}}^{\text{trans.}}$$

$$\Delta\omega_{\text{longitudinal}} = j \frac{I f_{\text{rf}}}{2\frac{E}{e}} \alpha_p \frac{f_0}{f_s} Z_{\text{eff}}^{\text{long.}}$$

- Related to narrow-band resonant impedance
 - Long-range wakefield
 - » RF cavities
 - » Resistive wall

- **Heating**

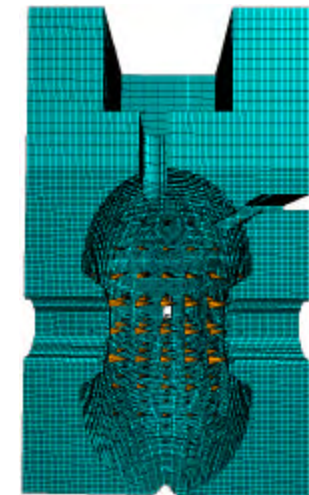
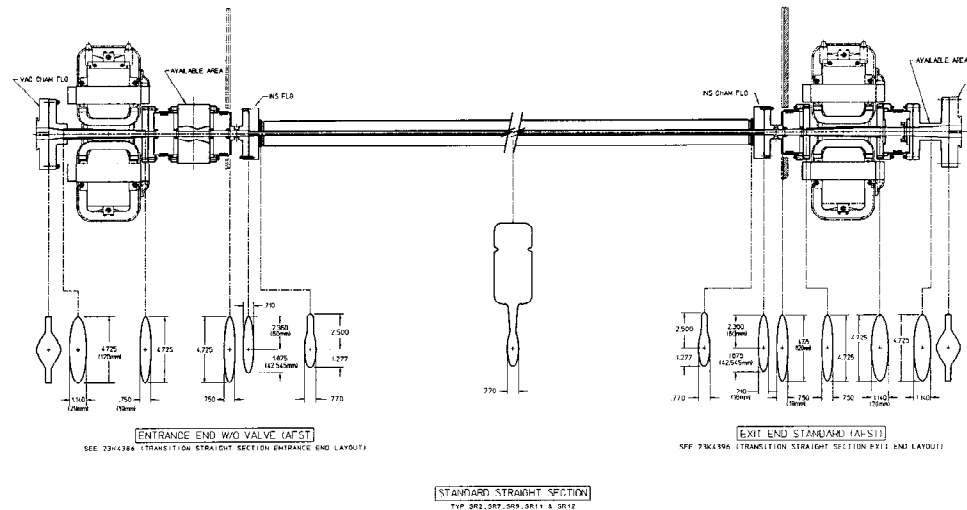
- Power deposited in a resistive impedance may cause heating and damage

“Impedance police”



- Minimize beam impedance at the design stage
 - Maintain instability thresholds above operating parameters
 - Avoid heating of uncooled components
 - Close interaction between physicists, engineers, and designers

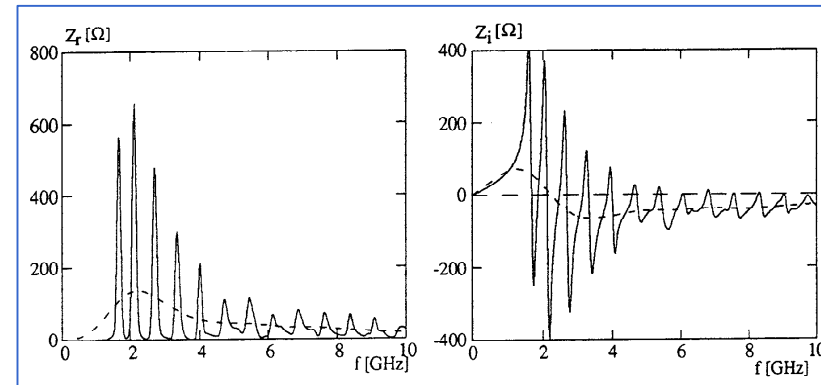
- tapers
- flanges
- synchr. radiation masks
- BPM's
- kickers
- resistive wall
- septum magnets
- beam scrapers
- pumping slots
- RF cavities
- etc



Broadband impedance calculation



- Single-bunch effects
- Time-domain analysis
- Calculate wakefield over length of bunch
- Not necessary to model all detail of structures
 - Require that fields that can catch up with the beam be properly included
 - Dominated by end effects in many devices
 - » striplines, synchrotron radiation slots, ...
- Loss factor
 - Energy loss to the bunch self-induced field



$$k = \frac{\int_{-\infty}^{\infty} W_z(\tau) i_b(\tau) d\tau}{q}$$

$$P = k T_0 I_b^2$$

Broadband impedance calculation

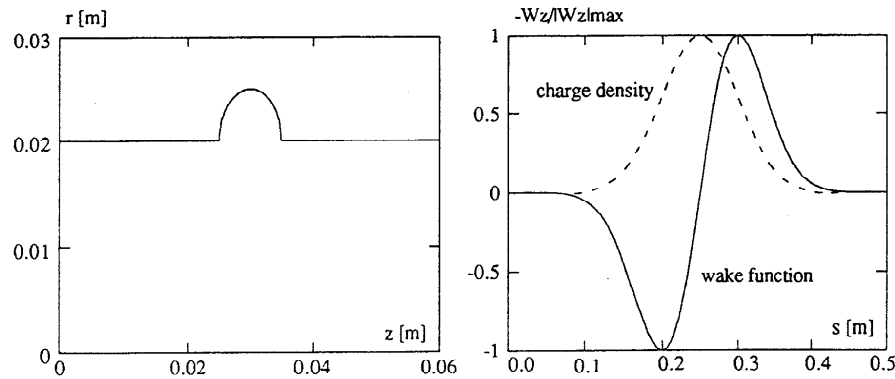


- Require “delta-function” or “Green’s function” wake for inclusion in self-consistent singlebunch phenomena modeling
 - Particle tracking
 - Numerical solution of Fokker-Planck equation
 - Modal analysis from Vlasov equation
 - Improvement over broadband impedance models
 - Require wake from very short bunch to generate an effective Green function
 - » Dense mesh
 - » Long run time

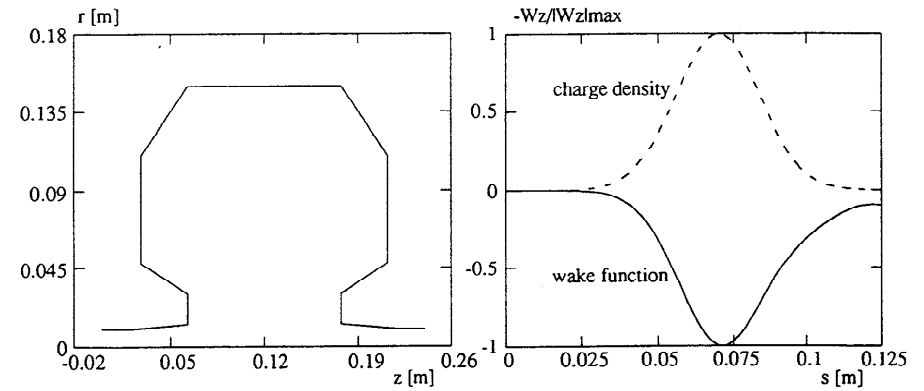
Broadband impedance calculation



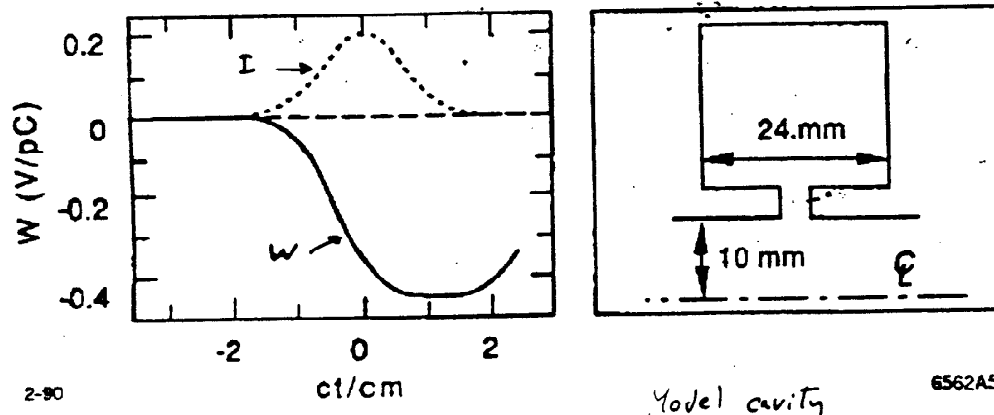
- Inductive wake



- Resistive wake



- Capacitive wake



2-90

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Yodel cavity



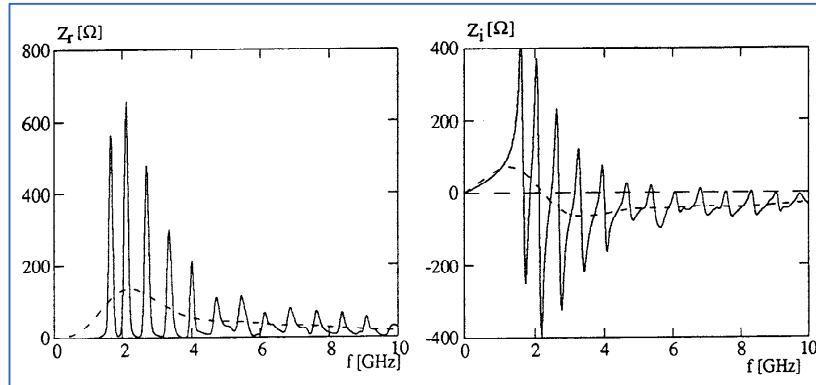
Narrowband impedance calculation



- Multi-bunch effects
- Important to include detail of structures
- Frequency domain analysis

- Calculate resonant-mode parameters

- F_{resonant} , Q , R/Q , T , ...



- Time domain analysis

- Calculate long-range wakefield
- Wake is calculated for lossless materials

- OK for heavily externally loaded structures

$$P(\omega) = \bullet \underbrace{I_b^2(\omega)}_{\text{beam spectrum}} R(\omega)$$

$$W_{\text{longitudinal}}(s) = - \bullet \frac{\omega_p}{2} \left(\frac{R}{Q} \right)_p e^{j \frac{\omega_p}{c} s} e^{-\frac{\omega_p}{2 Q_p} s}$$

Computer modeling



- **Time domain**

- Wakefields
 - “moving mesh” for short-range wakes
- Loss factor
- F.T. to frequency domain
 - resonant impedance information

- **Frequency domain**

- F_{resonant}
- Q
- R/Q
- Transit time T
- ...

- **Boundary conditions**

- E, H boundary conditions
 - Symmetry planes
- Periodic boundary conditions
 - Periodic structures (cavities)
- Waveguide boundary conditions
 - Damping waveguides
- Resistively matched boundaries
 - Broad-band match

Computer modeling



- **Finite-difference codes**

- MAFIA, GDFIDL, URMEL, ABCI, etc
- Rectangular meshing
 - May be crude geometric model
 - Large memory demands
 - Matrix includes points outside “active” volume
 - Many mesh points for improved accuracy

- **Boundary-element codes, etc**

- Not commonly used in this application

- **Finite-element codes**

- HFSS, ANSYS, SOPRANO, PRIAM, etc
- Efficient meshing with polygons
 - Good geometric fit
 - Mesh only the active volume
- Analysis less robust
 - “ghost modes”
 - Non-physical solutions
 - Maxwells equations may be solved explicitly on rectangular mesh

2-D / 3-D



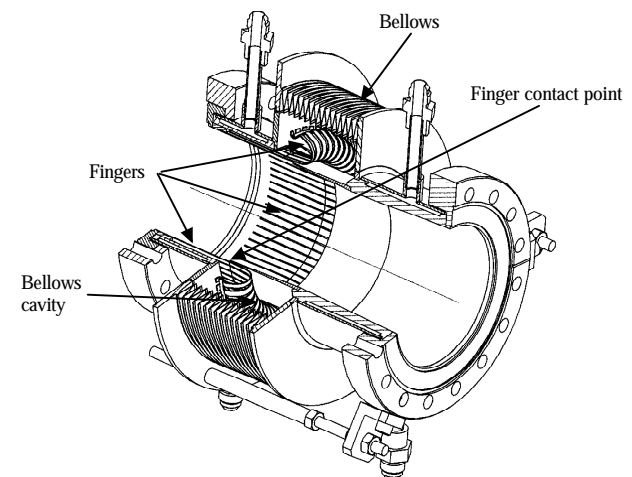
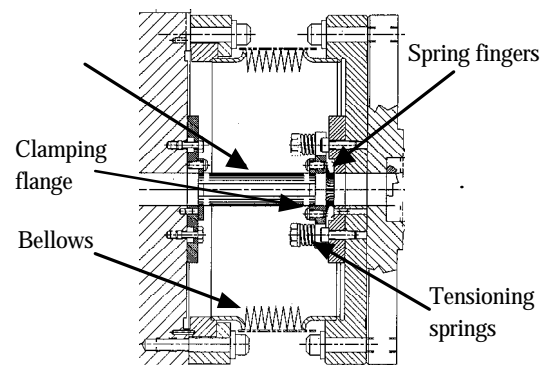
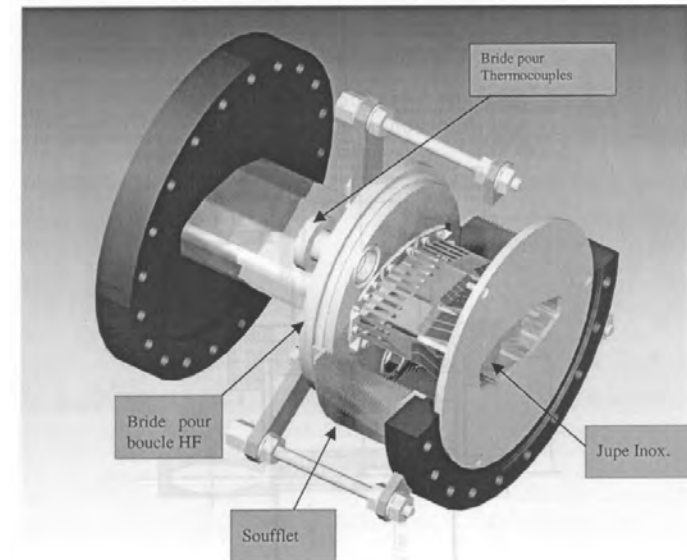
- 2-D
- Simple cylindrically symmetric geometries
- Define azimuthal variation for each computation run
 - m=0 (monopole)
 - m=1 (dipole) ... etc
 - Efficient use of memory and CPU time

- 3-D
- Allows complex geometries without longitudinal or azimuthal symmetry to be modeled
 - Gobbles up memory and CPU cycles

Bellows



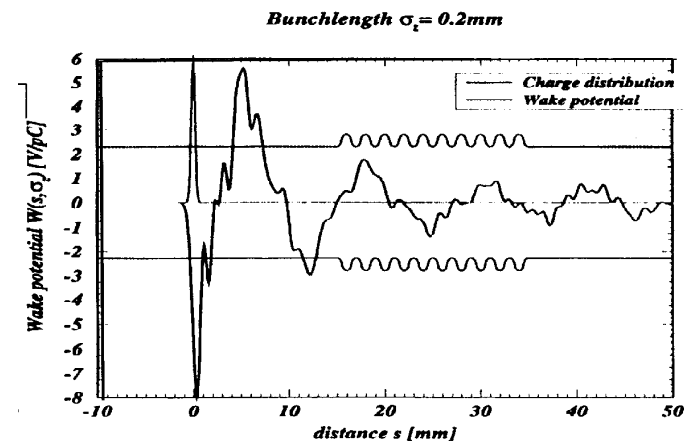
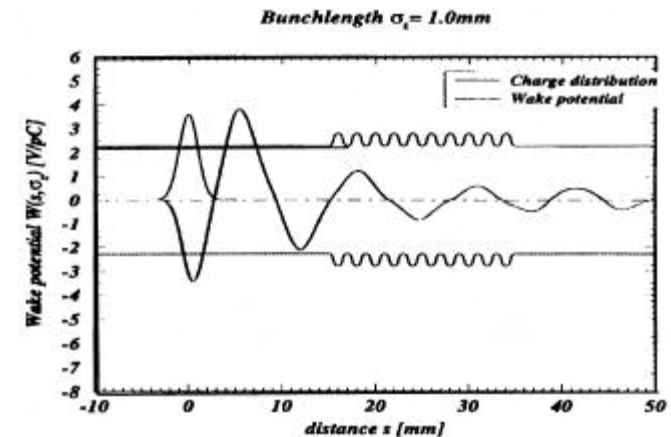
- Shield bellows with “smooth” conductors
 - Carry image currents
 - Prevent coupling to volume enclosed by bellows
 - Must have some compliance to allow bellows movement



Bellows



- Unshielded bellows have strong resonances
 - May drive instabilities
 - May be damaged by beam-induced heating
- Shielded bellows difficult to model
 - Intricate details of fingerstock
 - Small changes in cross-section at moving joints
 - Generally approximate model as solid with small step changes in cross-section at sliding joints



Tapers



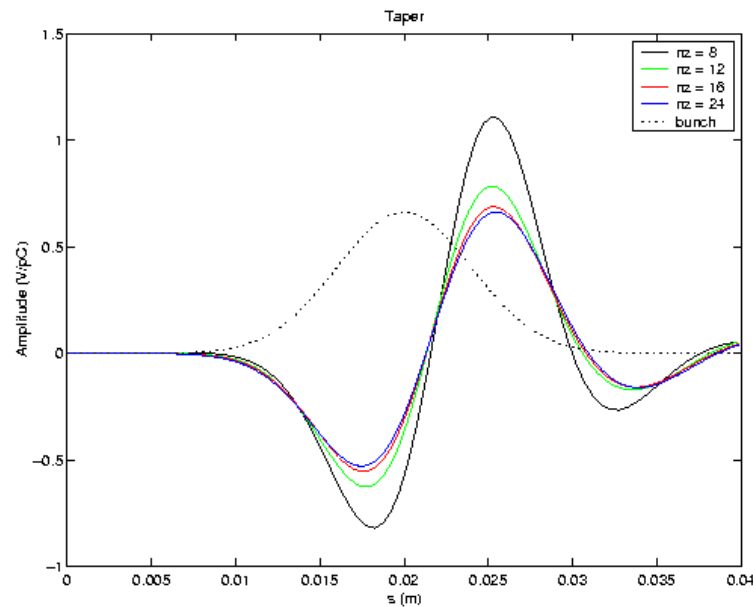
- Strongly inductive at low frequencies
- Minimize angle / maximize length
 - Smooth linear tapers as good as more complex shapes
- Generally model as pairs
 - Energy loss from outward taper, gain from inward taper
- Beware of cross-talk with adjacent components
 - May need to model longer sections of vacuum chamber
- Good agreement with theory for 2-D structures
 - Wakefield sensitive to mesh size
 - Ensure convergence
- Poor correlation extrapolating from 2-D to 3-D

Tapers



- Sensitivity to mesh size

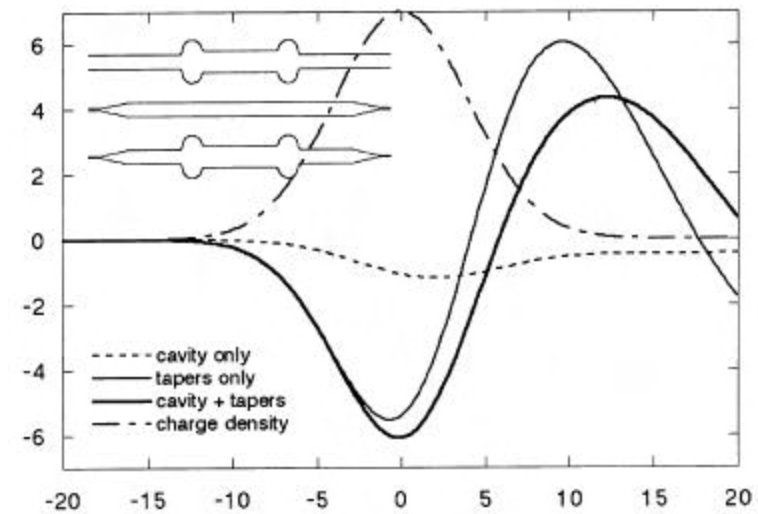
- 10:1 taper



- Ensure convergence as mesh size reduced

$$\frac{a\phi}{\Delta z} \frac{\sigma_s}{\Delta z} > 100$$

- Cavity / tapers wakes

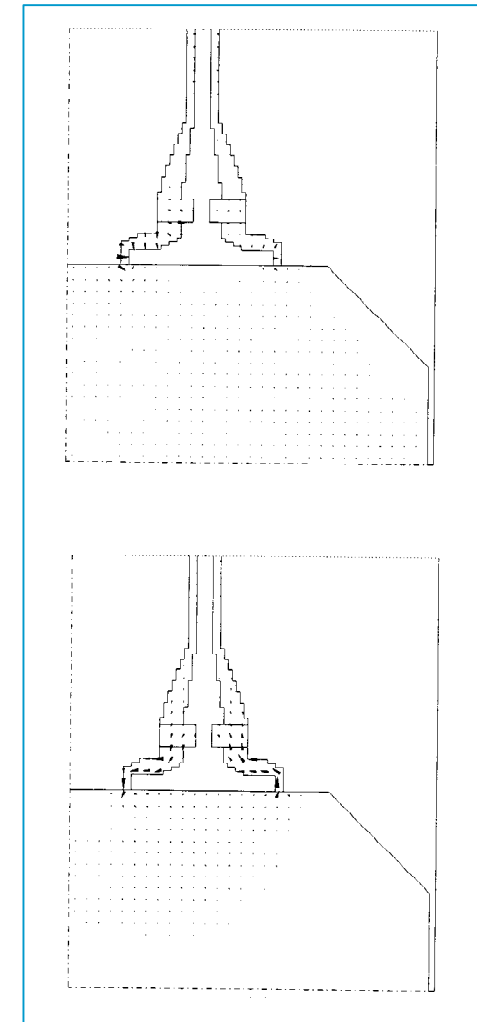
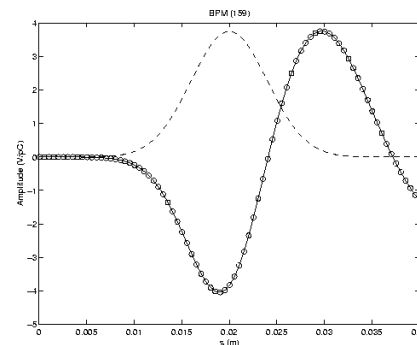
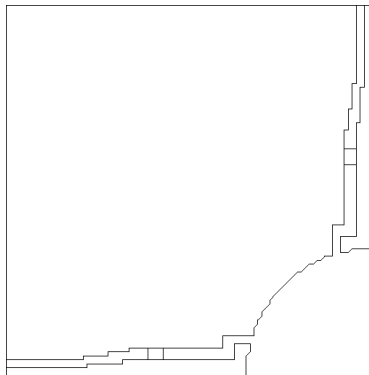


- Tapers dominate wake in this case

BPM's



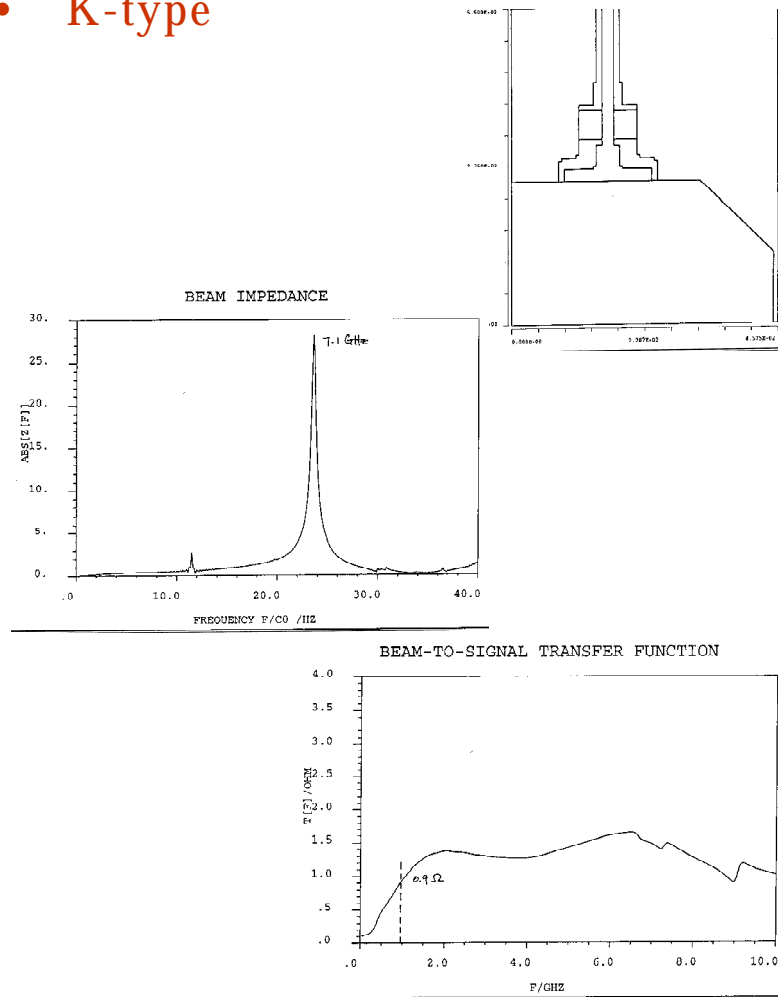
- High-frequency circumferential modes dominate impedance
 - Narrowband effects as well as low frequency inductance and resistance
 - Increase resonant frequency by making smaller buttons
 - De-Q resonance by introducing asymmetry
 - D-shaped button or perturbation to couple mode into coaxial line



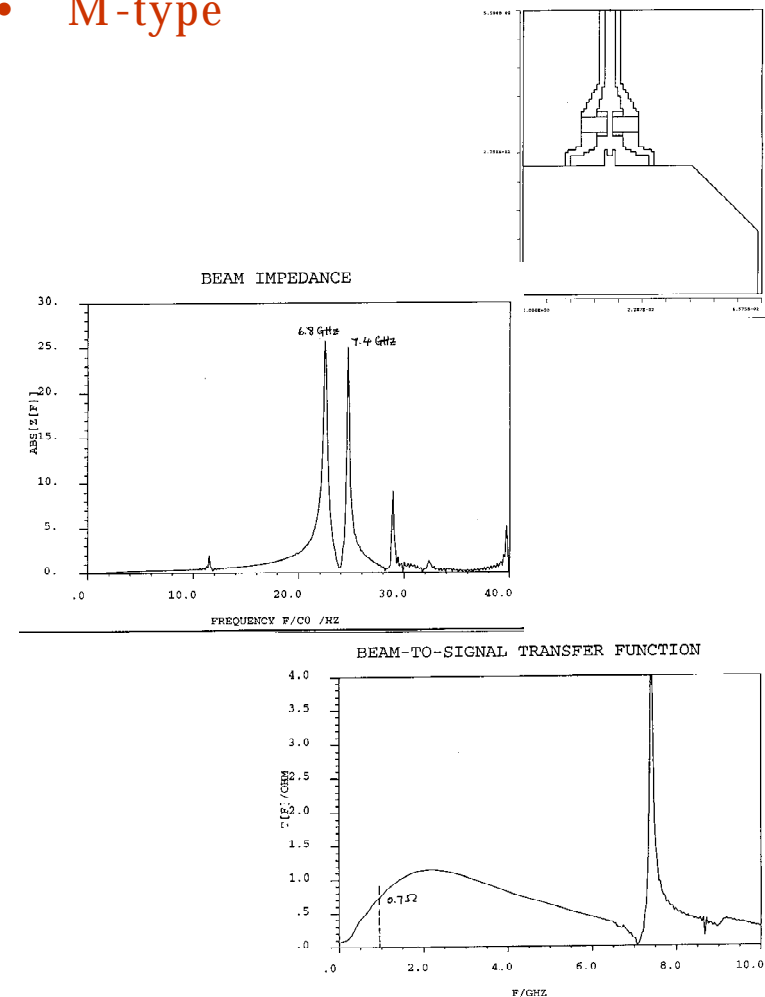
BPM's



- K-type



- M-type





Resistive wall

- Transverse
- Increasing radius helps but usually not an option
- Use high-conductivity materials where possible

$$W_1(s) = \frac{C}{b^3 \sigma_z^{1/2}} \frac{c}{2\pi} \sqrt{\frac{Z_0}{2\sigma_{d.c.}}} f(s/\sigma_z)$$

$$f(u) = |u|^{1/2} e^{-u^2/4} (I_{-1/4} \pm I_{1/4}) \Big|_{u^2/4}$$

- $\rho = 17.7 \text{ n}\Omega\text{-m Cu, } 33 \text{ n}\Omega\text{-m Al, } 900 \text{ n}\Omega\text{-m st. st.}$
- Transverse coupled-bunch motion dominated by resistive wall at low frequency

- Lowest mode determined by tune

$$\omega = 2 \pi f_{\text{orbit}} (1 - \Delta Q)$$

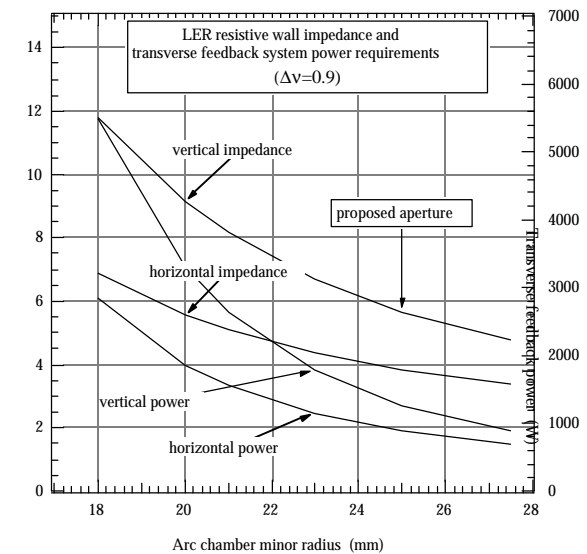
- Feedback systems may be required

$$Z_{\text{transverse}}^{\text{resistive wall}} = A (1+j) \frac{c L}{\pi b^3} \sqrt{\frac{\mu_0 \rho}{2}} \frac{1}{\sqrt{\omega}}$$

$$A_{\text{vertical}} = \pi^2/12$$

$$A_{\text{horizontal}} = \pi^2/24$$

$$A_{\text{circular}} = 1$$



Resistive wall



- Longitudinal

- Short-range wake is strong for very small vacuum chambers and short bunches

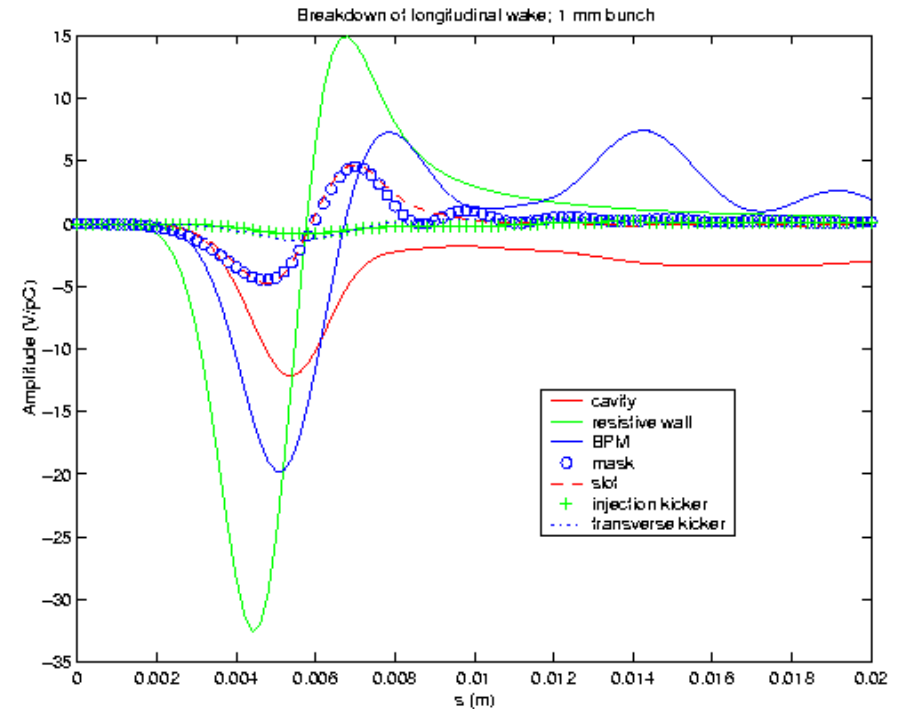
$$W_z(s) = \frac{C}{4b\sigma_z^{3/2}} \sqrt{\frac{c}{2\pi\sigma_{d.c.}}} f(s/\sigma_z)$$

$$f(u) = |u|^{3/2} e^{-u^2/4} (I_{1/4} - I_{3/4} - I_{-1/4} + I_{-3/4}) \Big|_{u^2/4}$$

- Resistive heating

$$P = \frac{L}{8\pi^2 r} I_0^2 \Gamma\left(\frac{3}{4}\right) \sqrt{\frac{\mu_0}{2\sigma_{dc}}} \frac{T_b}{\sigma_t^2}$$

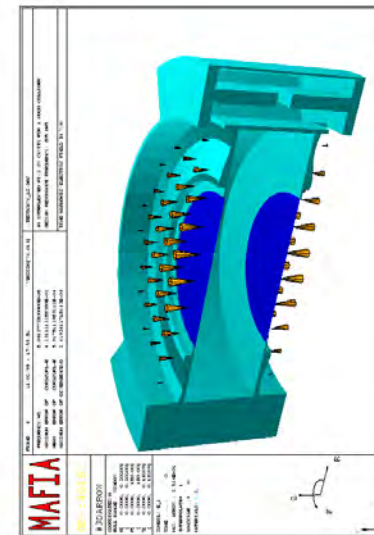
- May demand cooling of vacuum chambers



RF cavities - frequency domain



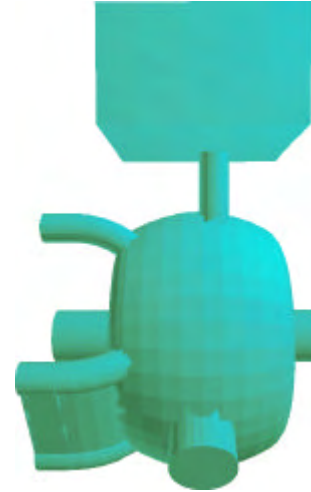
- Details of mode parameters
 - Must calculate many modes
 - Not all of interest
 - Damped cavities require careful analysis
 - Kroll-Yu method
 - Several runs with different waveguide lengths



RF cavities - time domain



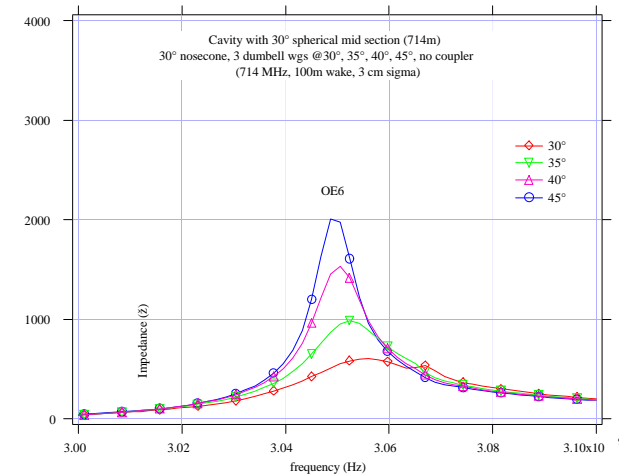
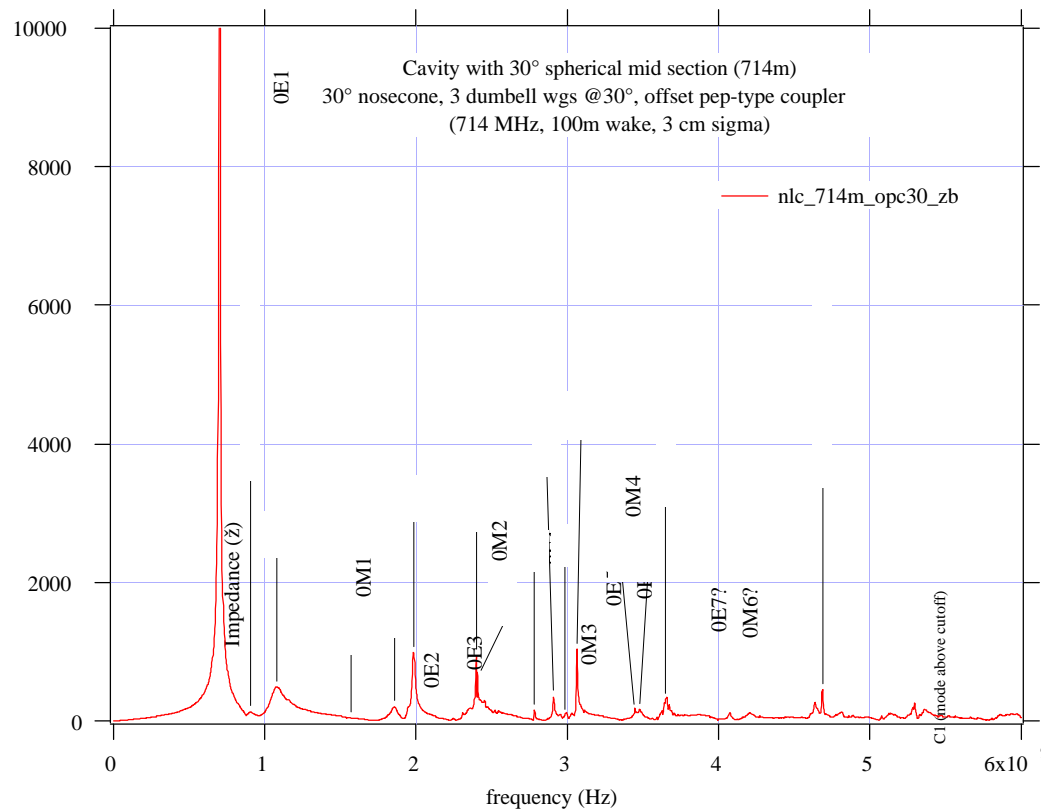
- Allows matched waveguide boundaries
 - Good for damped cavities
 - Many modes sampled in one run
 - Long wake required to resolve modes
 - Less accurate mode parameters
 - Calculated wake is for lossless materials
 - OK if heavily damped (externally loaded)



HOM damping



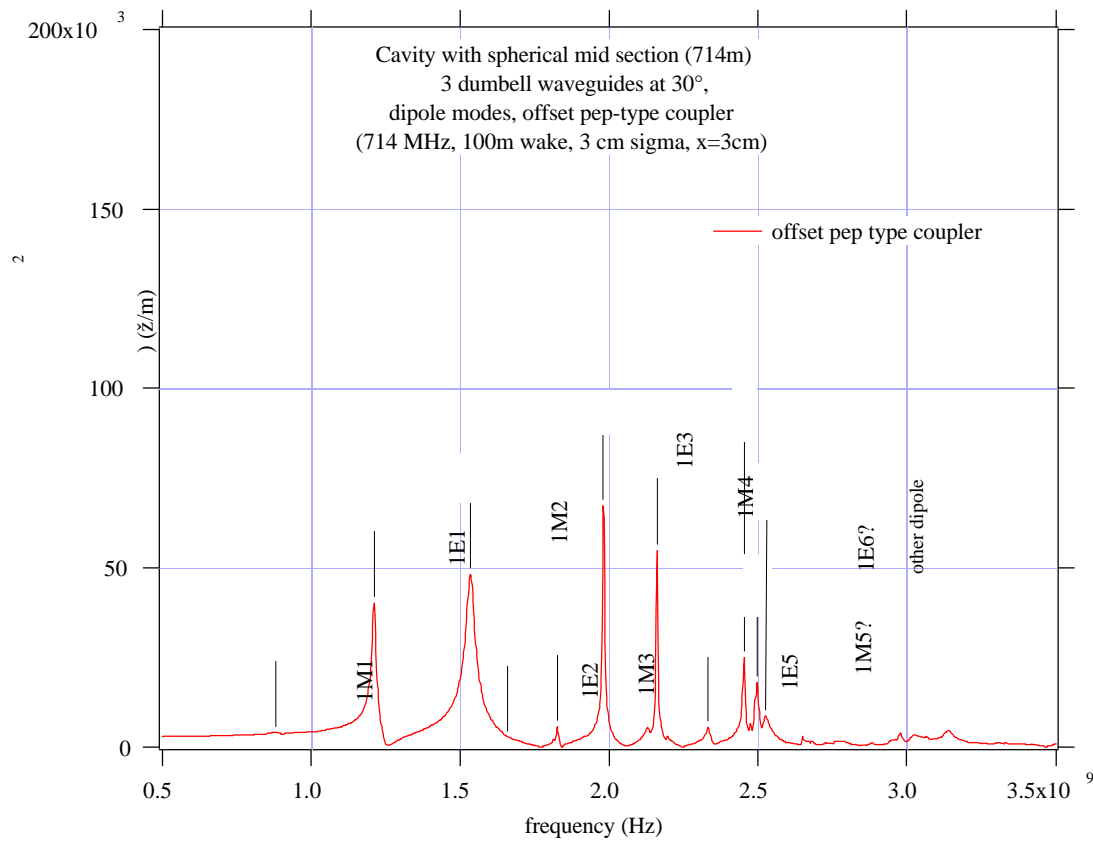
- Longitudinal



HOM damping

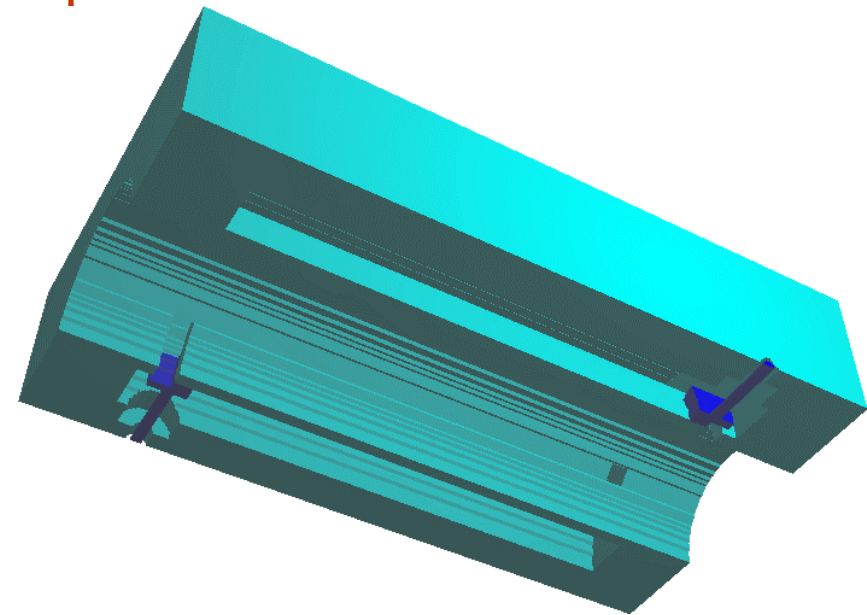
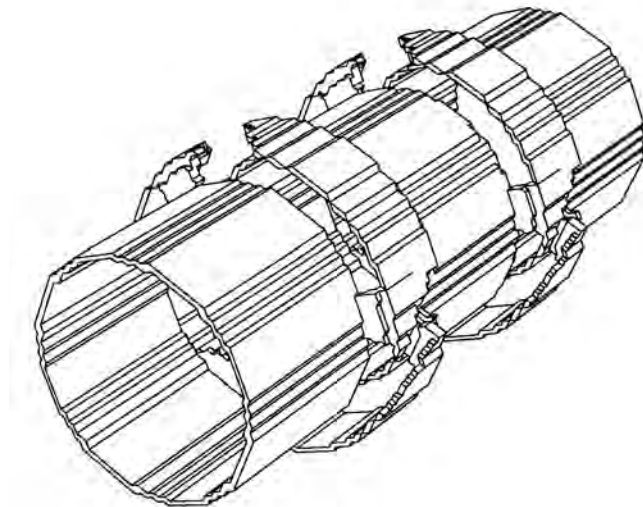


- Transverse



Kicker structures

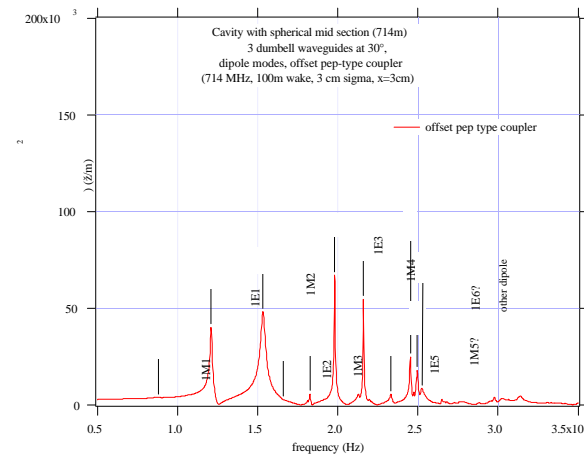
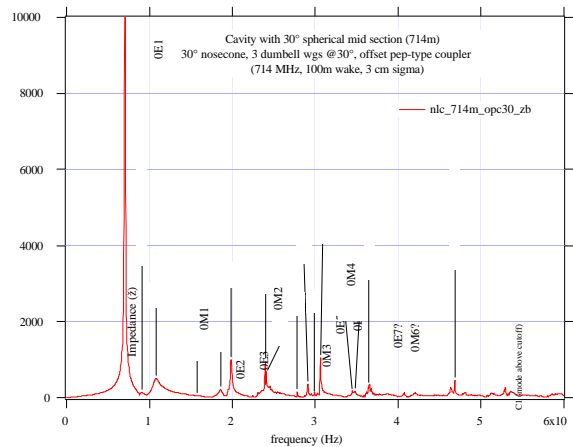
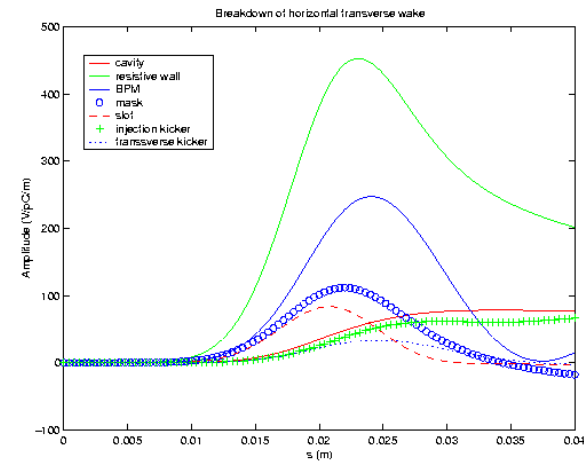
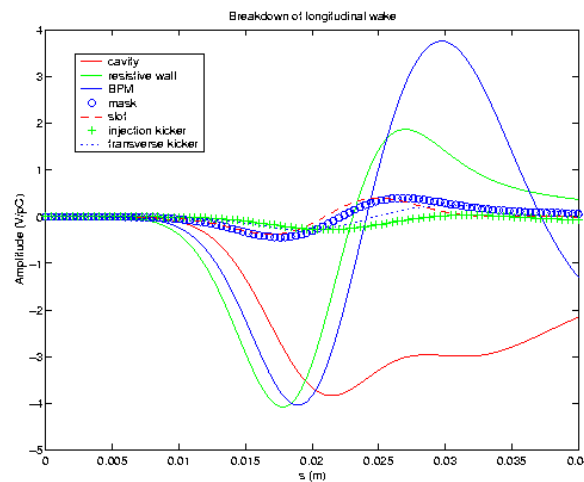
- End effects often adequate for broadband impedance
- Resonant effects
 - Careful model including more structure details
 - Beware of details!
- Parasitic resonances may be damped with antennae



Total wake



- For NLC main damping rings



Conclusions



- Computational tools for impedance calculation are highly developed
- Several techniques available for many calculations
- Computing power now sufficient to allow complex geometries
 - 1,000,000 mesh points
 - 100's meters wake
 - " 24 hrs CPU time
- Wakefield calculations for single-bunch effects
 - Use Green function wake in simulation codes
- Simple to use F.T. to optimize HOM damping in cavities
- Frequency domain for devices with few resonances